Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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LASER DIODE

NDL7401P Series

1 310 nm InGaAsP STRAINED MQW DC-PBH LASER DIODE COAXIAL MODULE WITH SINGLE MODE FIBER

DESCRIPTION

NDL7401P Series is 1 310 nm laser diode coaxial module with single mode fiber. It has a strained Multiple Quantum Well (st-MQW) structure and a built-in InGaAs monitor photo diode. It is recommended for junction and access network systems.

The series is also available in FC-PC and SC-PC connector.

FEATURES

• Center wavelength $\lambda c = 1 \ 310 \ nm$ • High output power from fiber $P_f = 2.0 \ mW \ MIN.$

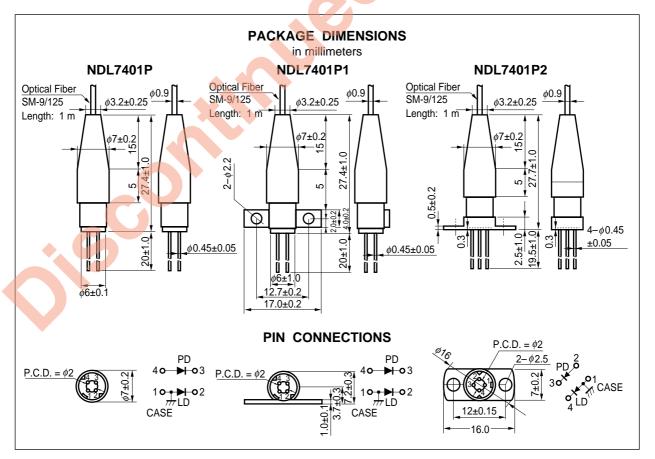
Low threshold current
 Ith = 10 mA TYP. @Tc = 25 ℃

High cut-off frequency fc = 2.0 GHz

• InGaAs monitor PIN-PD

Wide operating temperature range Tc = -40 to +85 °C

• Based on Bellcore TA-NWT-000983



The information in this document is subject to change without notice.

ORDERING INFORMATION

Part Number	Available Connector	Description	
NDL7401P	Without Connector	No Flange	
NDL7401PC	With FC-PC Connector		
NDL7401PD	With SC-PC Connector		
NDL7401P1	Without Connector	Flat Mount Flange	
NDL7401P1C	With FC-PC Connector		
NDL7401P1D	With SC-PC Connector		
NDL7401P2	Without Connector	Vertical Flange	
NDL7401P2C	With FC-PC Connector		
NDL7401P2D	With SC-PC Connector		

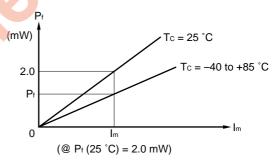
ABSOLUTE MAXIMUM RATINGS (Tc = 25 °C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Forward Current of LD	lF	Ith + 50	mA
Reverse Voltage of LD	VR	2.0	V
Forward Current of PD	lf	10	mA
Reverse Voltage of PD	VR	20	V
Operating Case Temperature	Tc	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
Lead Soldering Temperature (10 s)	T _{sld}	260	°C

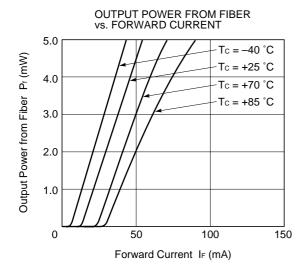
ELECTRO-OPTICAL CHARACTERISTICS (Tc = 25 °C, unless otherwise specified)

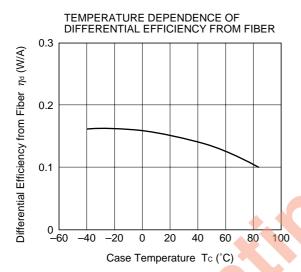
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Operating Voltage	Vop	Pf = 2.0 mW		1.1	1.3	V
Threshold Current	Ith			10	25	mA
		Tc = 85 °C		25	50	
Modulation Current	Imod	P _f = 2.0 mW		15	20	mA
Differential Efficiency from Fiber	$\eta_{ extsf{d}}$		0.100	0.150		W/A
		Tc = 85 °C	0.075	0.100		
Center Emission Wavelength	λο	Pf = 2.0 mW, RMS (-20 dB)	1 290	1 310	1 330	nm
		Tc = -40 to +85 °C	1 260		1 360	
Temperature Dependence of Center Emission Wavelength	Δλ/ΔΤ	Tc = -40 to +85 °C		0.4	0.5	nm/°C
Spectral Width	σ	P _f = 2.0 mW, RMS (–20 dB)		1.3	2.5	nm
		Tc = 85 °C		1.5	4.0	
Rise Time	tr	10 to 90 %		0.2	0.5	ns
Fall Time	tr	90 to 10 %		0.3	0.5	ns
Monitor Current	Im	V _R = 5 V, P _f = 2.0 mW	100	700		μΑ
Monitor Dark Current	ΙD	V _R = 5 V		0.1	10	nA
Tracking Error	γ*1	$I_m = const.$, $T_c = -40$ to $+85$ °C			1.0	dB

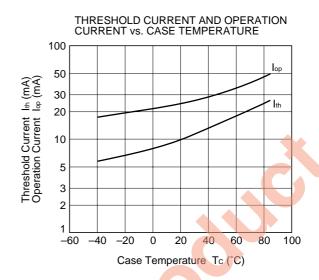


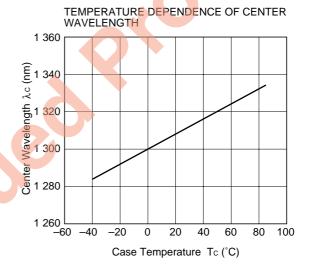


★ TYPICAL CHARACTERISTICS (Tc = -40 to +85 °C)

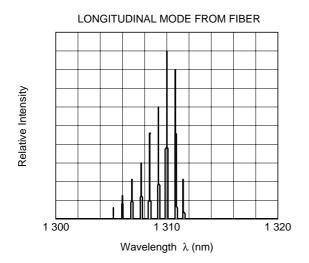


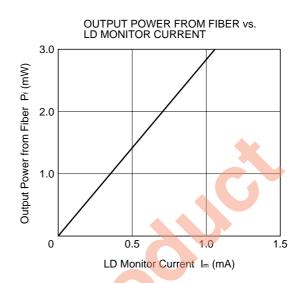


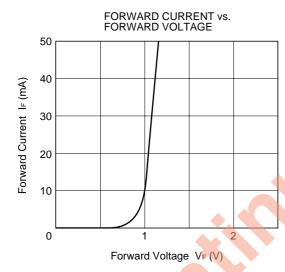


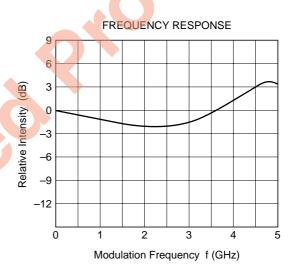


TYPICAL CHARACTERISTICS (Tc = 25 °C)











1.3 μm FABRY-PEROT DC-PBH LASER DIODE FAMILY

Package	Part Number	Remarks
φ5.6 mm Small Can	NDL7001	With monitor photo diode
φ5.6 mm Small Can with Lens	NDL7001L	With monitor photo diode
4-pin Coaxial Module with SMF	NDL7401P Series NDL7408P Series	Without TEC With monitor photo diode

REFERENCE

Document Name	Document No.	
NEC semiconductor device reliability/quality control system	LEI-1201	
Quality grades on NEC semiconductor devices	IEI-1209	
Semiconductor device mounting technology manual	C10535E	
Guide to quality assurance for semiconductor devices	MEI-1202	
Semiconductor selection guide	X10679E	



[MEMO]



CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.



SEMICONDUCTOR LASER



AVOID EXPOSURE-Invisible Laser Radiation is emitted from this aperture

NEC Corporation NEC Building, 7-1, Shiba 5-chome, Minato-ku, Tokyo 108-01, Japan

Type number: Manufactured:

Serial Number: This product conforms to FDA

regulations as applicable to standards 21 CFR Chapter 1. Subchapter J.

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NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster

systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices in "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact NEC Sales Representative in advance.

Anti-radioactive design is not implemented in this product.